TOSHIBA LED Lamps

TLRMH1100A (T11), TLSH1100A (T11), TLOH1100A (T11), TLYH1100A (T11)

Panel Circuit Indicator

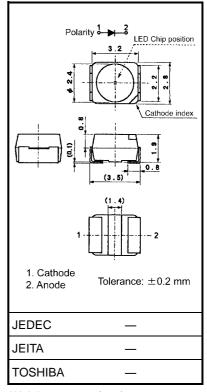
Unit: mm

- Surface-mount devices
- $3.2 (L) \times 2.8 (W) \times 1.9 (H) mm$
- Flat-top type
- InGaAlP LEDs
- High luminous intensity
- Low drive current, high-intensity light emission
- Colors: red, orange, yellow
- Reflow soldering possible
- Applications: automotive use, message signboards, backlighting etc.
- Standard embossed tape packing: T11 (2000/reel)

8-mm tape reel

Color and Material

Product Name	Color	Material
TLRMH1100A	Red	
TLSH1100A	Red	InGaA{P
TLOH1100A	Orange	IIIGAAIP
TLYH1100A	Yellow	



Weight: 0.035 g (typ.)



Maximum Ratings (Ta = 25°C)

Product Name	Forward Current I _F (mA)	Reverse Voltage V _R (V)	Power Dissipation P _D (mW)	Operation Temperature T _{opr} (°C)	Storage Temperature T _{stg} (°C)
TLRMH1100A					
TLSH1100A	70	4	161	−40~110	−40~110
TLOH1100A	70	4	101	-40~110	-40~110
TLYH1100A					

Electrical Characteristics (Ta = 25°C)

Product Name	Forward Voltage V _F				Reverse Current I _R	
	Min	Тур.	Max	I _F	Max	V_{R}
TLRMH1100A	_	1.9	2.3	20	10	4
TLSH1100A	_	1.9	2.3			
TLOH1100A	_	2.0	2.3			
TLYH1100A	_	2.0	2.3			
Unit		V		mA	μА	٧

Optical Characteristics-1 (Ta = 25°C)

Product Name	Luminous Intensity I _V				
Product Name	Min	Тур.	Max	l _F	
TLRMH1100A	63	150	_		
TLSH1100A	160	260	_	20	
TLOH1100A	160	270	_	20	
TLYH1100A	100	220	_		
Unit		mcd		mA	

Optical Characteristics-2 (Ta = 25°C)

	Emission Spectrum							
Product Name	_	ak Emiss avelength		Δλ	Domina	nt Wavele	ength λ _d	Ιϝ
	Min	Тур.	Max	Тур.	Min	Тур.	Max	
TLRMH1100A	_	636	_	17	_	626		
TLSH1100A	_	623	_	17	_	613		20
TLOH1100A	_	612	_	15	_	605		20
TLYH1100A	_	590	_	15	_	587		
Unit		nm		nm		nm		mA

Note: This visible LED lamp also emits some IR light.

If a photodetector is located near the LED lamp, please ensure that it will not be affected by the IR light.

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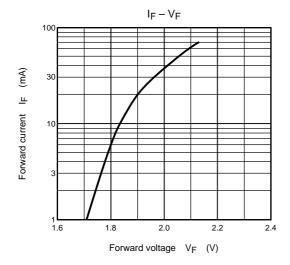
I_V – I_F

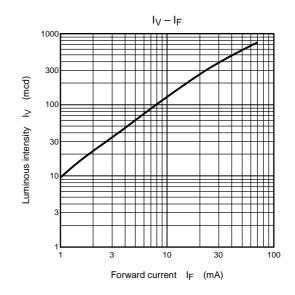
Luminous intensity Iv (mcd)

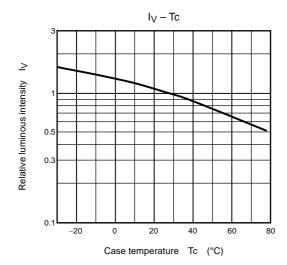
Forward current I_F (mA)

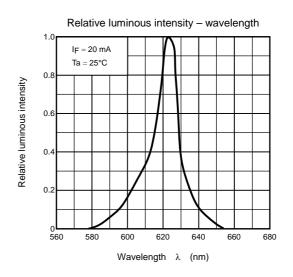
Relative luminous intensity

TLSH1100A



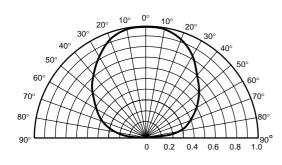


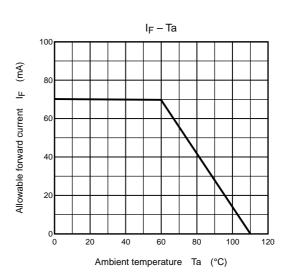




Radiation Pattern

Ta = 25°C



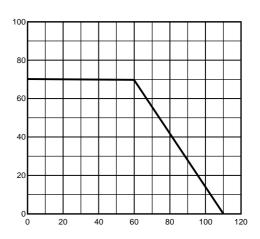


TLOH1100A

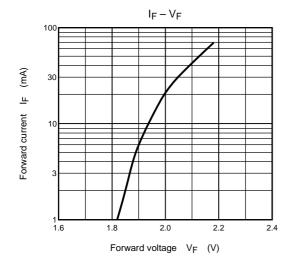
 $I_F - V_F$

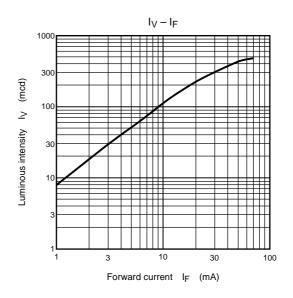
Forward voltage V_F (V)

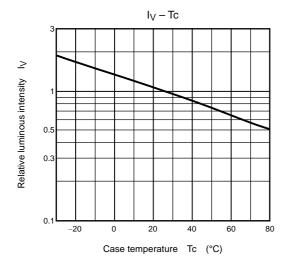
Relative luminous intensity

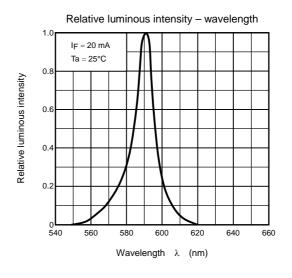


TLYH1100A



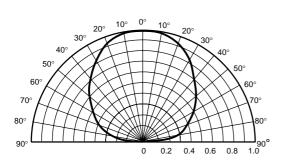


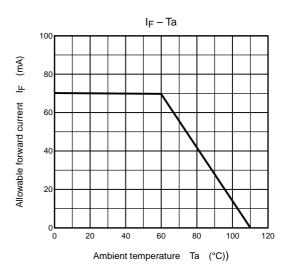




Radiation Pattern

Ta = 25°C





Packaging

These LED devices are packed in an aluminum envelope with a silica gel and a moisture indicator to avoid moisture absorption. The optical characteristics of the devices may be affected by exposure to moisture in the air before soldering and they should therefore be stored under the following conditions:

1. This moisture proof bag may be stored unopened within 12 months at the following conditions. Temperature: $5^{\circ}C{\sim}30^{\circ}C$

Humidity: 90% (max)

- 2. After opening the moisture proof bag, the devices should be assembled within 168 hours in an environment of 5° C to 30° C/ 60° RH or below.
- 3. If upon opening, the moisture indicator card shows humidity 30% or above (Color of indication changes to pink) or the expiration date has passed, the devices should be baked in taping with reel.

 After baking, use the baked devices within 72 hours, but perform baking only once.

Baking conditions: 60±5°C, for 12 to 24 hours.

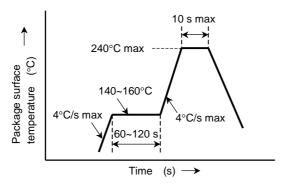
- Expiration date: 12 months from sealing date, which is imprinted on the same side as this label affixed.
- 4. Repeated baking can cause the peeling strength of the taping to change, then leads to trouble in mounting. Furthermore, prevent the devices from being destructed against static electricity for baking of it.
- 5. If the packing material of laminate would be broken, the hermeticity would deteriorate. Therefore, do not throw or drop the packed devices.

Mounting Method

Soldering

· Reflow soldering





- Please perform the first reflow soldering with reference to the above temperature profile and within 168 h of opening the package.
- Second reflow soldering

In case of second reflow soldering should be performed within 168 h of the first reflow under the above conditions.

Unit: mm

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Storage conditions before the second reflow soldering: 30°C, 60% RH max

• Make any necessary soldering corrections manually.

(only once at each soldering point)

 $\begin{array}{lll} \text{Soldering iron: 25 W} \\ \text{Temperature} &: 300^{\circ}\text{C or less} \\ \text{Time} &: \text{within 3 s} \end{array}$

Recommended soldering pattern

1.65

2001-12-05



Cleaning

8 2001-12-05



5. Packing display

(1) Packing quantity

Reel	2,000 pcs
Carton	10,000 pcs

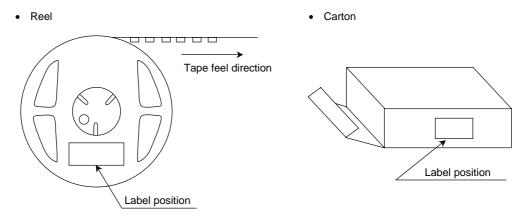
(2) Packing form: Each reel is sealed in an aluminum pack with silica gel.

6. Label format

(1) Example: TLSH1100A (T11)

P/N:			
TYPE	TLSH1100A		
ADD.C	(T11)	Q'TY	2,000 pcs
NOTE			Lot Number
(RANK SYMBOL	_)		

(2) Label location



 The aluminum package in which the reel is supplied also has the label attached to center of one side.

RESTRICTIONS ON PRODUCT USE

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- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc..
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's own risk.
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 products, follow the appropriate regulations. Do not dispose of the products with other industrial waste or with
 domestic garbage.
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